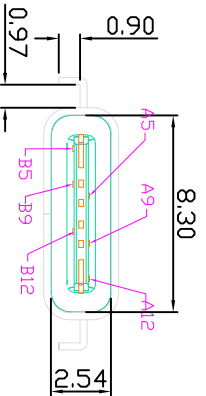


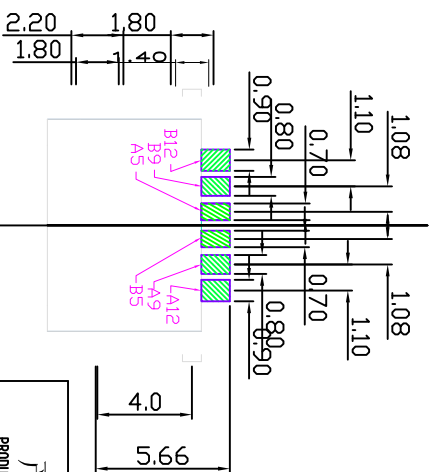
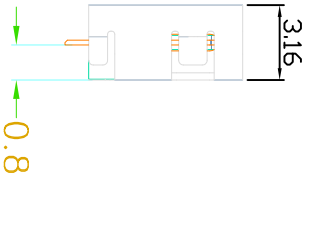
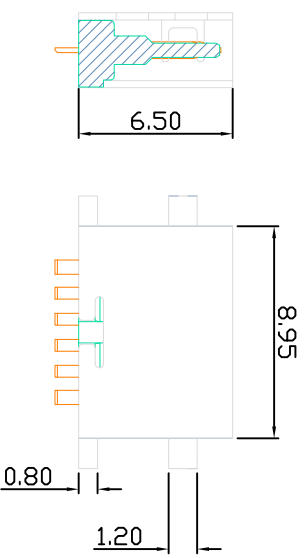
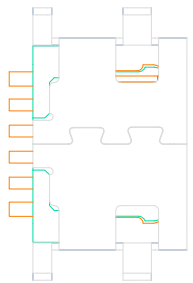
ROHS

Autodesk 教育版产品制作

MAPX	MODIFICATION	DRW	DATE



B12	GND
B9	VBUS
B5	CC2
A5	CC1
A9	VBUS
A12	GND
PIN	SIGNAL NAME



NOTES:

1. MATERIAL:
  - MOLDING: LCP UL94 V-0
  - CONTACT: COPPER ALLOY.
  - GOLD PLATED Min ON CONTACT AREA, 100u"
  - Min TIN (LEAD FREE) ON SOLDER AREA,
  - SHELL: SUS304-H,T=0.30±0.03mm
  - 50u" NICKEL PLATING OVER ALL.
2. MECHANICAL:
  - INSERTION: 5~20N.
  - EXTRACTION: 8~20N AFTER TEST.
  - DURABILITY: 10000 CYCLES
3. ELECTRICAL:
  - CURRENT: 5A FOR VBUS;
  - 1.25A FOR GND PIN.
  - 0.25A FOR OTHER.
  - VOLTAGE: 20 V MAX
  - WITHSTANDING VOLTAGE: 100V AC R.M.S.
  - CONTACT RESISTANCE: 40mΩ MAX.
  - INSULATION RESISTANCE: 100MΩ MIN.
4. ENVIRONMENTAL
  - TEMPERATURE RANGE -25°C ~ +85°C
5. 尺寸标注事项:
  - 图示有标注者为首检全检、重点管控尺寸。
  - 产品符合RoHS标准。

Table:

成品料号	零件名称	零件料号	材料 / 电镀
TX	端子	SUS 304 R-H	NO PLATING
	注塑半成品	SUS 301 R-H	Sn 80~200u"
	塑胶材料	SUS 301 R-H	电镀切料前压。
	外壳	TX	

深圳市精拓金电子有限公司  
Shenzhen Jing Tuo Jin Electronics Co., Ltd.

产品图  
公差一览表  
TOLERANCE UNLESS OTHERWISE

X	+0.25	X	+5°
X	+0.20	X	+2°
XX	+0.15	XX	+1°
XXX	+0.10	XXX	+0.5°

单位	MM	制图	许榕强	制图料号
UNITS	MM	DRAWING	审核	产品名称
比例	1:1	CHNO	郭志富	PRODUCT NO.
日期	2016-09-09	核准	黄国荣	角法
DATE		APPD		版本
				A0

